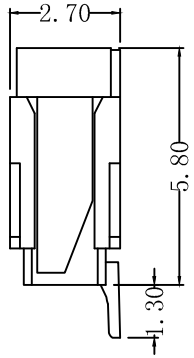
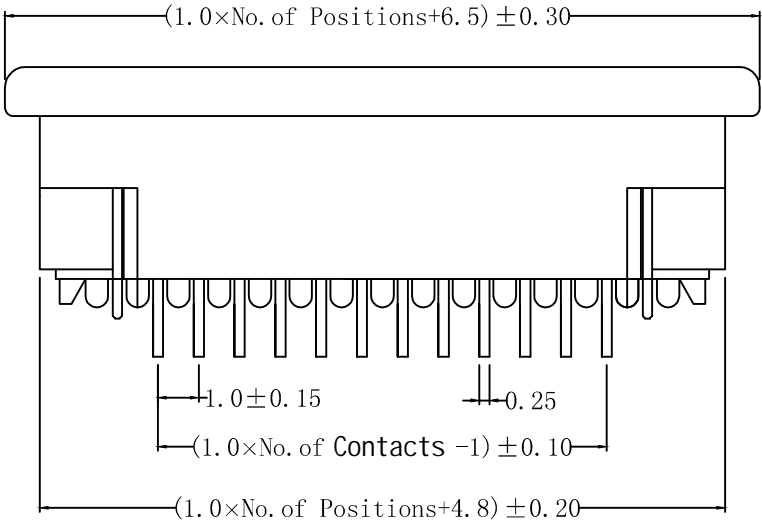
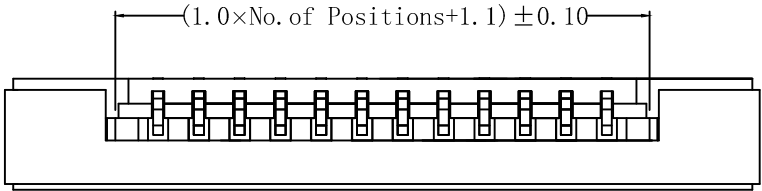


REV	DESCRIPTION	DATE



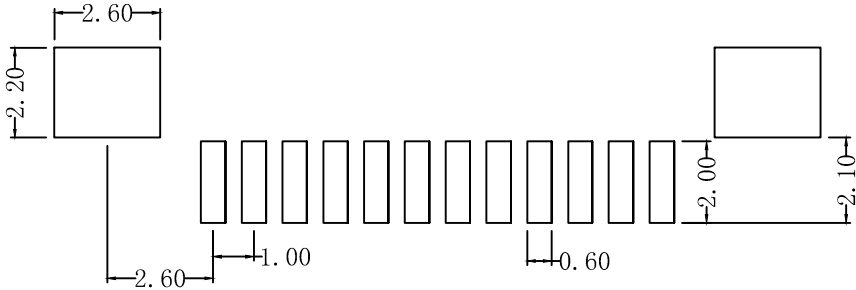
■ NOTE:

MATERIAL:

HOUSING: HIGH TEMPERATURE THERMOPLASTIC.
 COVER: HIGH TEMPERATURE THERMOPLASTIC.
 CONTACT: COPPER ALLOY.
 HOLDDOWN: COPPER ALLOY.

■ PART NO.

CNT-FPC100-XX-TDM-S20-270



RECOMMENDED PCB LAYOUT

<p>CNT 肯耐特电子有限公司</p>				GENERAL TOLERANCE		DRAWN		DATE		DWG. NO.		TITLE	
				X. ° ± 5°	X. ± 0.30	董道丽		20191011		PART. NO.			
REV. 1.0	UNIT mm	SCALE 1:1		. XX ° ± 3°	. X ± 0.38	CHECK		DATE				CNT-FPC100-XX-TDM-S20-270	
				. XX ° ± 2°	. XX ± 0.25	王芳芳		20191011					
				. XXX ° ± 1°	. XXX ± 0.15	王元中		20191011					